

## **☆TDK** Multilayer Ceramic Chip Capacitors

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Creation Date: May 06, 2014

## C2012X7R2A103K085AA (TDK item description: C2012X7R2A103KT\*\*\*\*)

**Applications** 



Commercial Grade



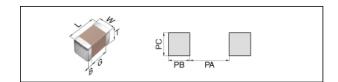
Please refer to Part No. CGA4F2X7R2A103K085AA for automotive use.

Feature

Mid Voltage (100 to 630V)

Series

C2012 [EIA CC0805]











Size		
Length(L)	2.00mm +/-0.20mm	
Width(W)	1.25mm +/-0.20mm	
Thickness(T)	0.85mm +/-0.15mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.50mm Min.	
Recommended Land Pattern(PA)	1.00 to 1.30mm (Flow Soldering) < br /> 0.90 to 1.20mm (I	Reflow Soldering)
Recommended Land Pattern(PB)	1.00 to 1.20mm (Flow Soldering) br />0.70 to 0.90mm (I	Reflow Soldering)
Recommended Land Pattern(PC)	0.80 to 1.10mm (Flow Soldering) < br /> 0.90 to 1.20mm (I	Reflow Soldering)
Recommended Slit Pattern(SD)		

Electrical Characteristics		
Capacitance	10nF +/-10%	
Rated Voltage	100Vdc	
Temperature Characteristic	X7R(+/-15%)	
Dissipation Factor	3% Max.	
Insulation Resistance	10000MΩ Min.	

Other		
Soldering Method	Reflow, Flow	
AEC Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000Pcs Min.	

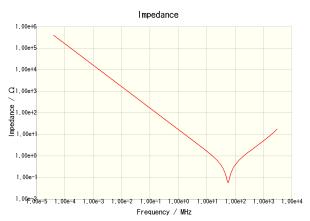
<sup>•</sup>This PDF document was created based on the data listed on the TDK Corporation website.

<sup>•</sup>All specifications are subject to change without notice.

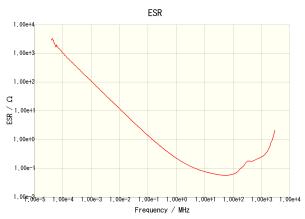
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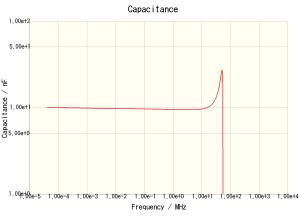
## Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



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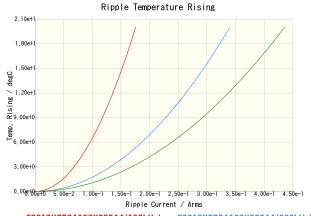
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C2012X7R2A103K085AA



C2012X7R2A103K085AA(DC Bias = 0V)2012X7R2A103K085AA(DC Bias = 50V)



C2012X7R2A103K085AA(100kHz)

C2012X7R2A103K085AA(500kHz)

C2012X7R2A103K085AA(1MHz)

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